IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

re patent application of: Wang et al.

Attorney Docket: 99A209

Serial No.: 09/583,599

Group Art Unit: 1711

Filed: May 31, 2000

Examiner: Thoa T. Tran

Title: IMPROVED ACID COPPER ELECTROPLATING SOLUTIONS

COMMISSIONER FOR PATENTS P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

RESPONSE

In response to the Office Action dated June 24, 2004, please amend the above application as set forth below.

An amendment to the claims begins on page 2 of this response.

A response to the Office Action dated June 24, 2004 begins on page nine (9) of this response.

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450 Alexandria, VA 22313-1450, on November 23, 2004.

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